508172457 10/13/2023

PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:	EXECUTIVE ORDER 9424, CONFIRMATORY LICENSE

CONVEYING PARTY DATA

Name	Execution Date
CHIP DESIGN SYSTEMS, INC	09/19/2023

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17828337

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DATE SIGNED:	10/13/2023	

Total Attachments: 1

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PATENT REEL: 065237 FRAME: 0793 508172457

CONFIRMATORY INSTRUMENT

APPLICATION FOR (TITLE OF INVENTION)				
APPLICATION FOR (TITLE OF INVENTION)				
LED Driver Circuitry for an Infrared Scene Projector	r System			
ELB Briver Officially for all fillinated decire i rejector	- Cystom			
INVENTORS(S)				
•				
Fouad Kiamilev				
SERIAL NO.	FILING DATE			
17/828,337	May 31, 2022			
CONTRACTOR Chip Design Systems, INC	CONTRACT NO.			
Chip Design Systems, INC	W900KK-17-C-0012			
The Invention identified above is a "Subject Invention" under Pate	ent Rights Clause			
·	(identify clause by title and date)			
FAR 52.227-11 (MAY 2014)	with tract No W900KK-17-C-0012 with			
	tract No with			
U.S. Army				
(specify government agency)				
This document confirms the paid-up license granted to the gover	mment under this contract in this invention, patent application, and			
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Signed this September day of 19th , 20	2023			
day of tay of, 20				
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	_//			
	CONTRACTOR			
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